

Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 20 to 200 V

Forward Current - 5 A

FEATURES

- ♦Metal silicon junction, majority carrier conduction
- ♦For surface mounted applications
- ♦Low power loss, high efficiency
- ♦High forward surge current capability
- ♦For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ♦Lead free in comply with EU RoHS 2011/65/EU directives



MECHANICAL DATA

- ♦Case: SMBF
- ♦Terminals: Solderable per MIL-STD-750, Method 2026
- ♦Approx. Weight: 57mg / 0.002oz

Pinning

1.Cathode	2.Anode
	
	
SMBF	

Marking Code

SS52BF	S52B
SS54BF	S54B
SS56BF	S56B
SS58BF	S58B
SS510BF	S510B
SS512BF	S512B
SS515BF	S515B
SS520BF	S520B

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 ° ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS52BF	SS54BF	SS56BF	SS58BF	SS510BF	SS512BF	SS515BF	SS520BF	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	5.0								A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed On Rated Load (JEDEC method)	I_{FSM}	150								A
Maximum Instantaneous Forward Voltage at 5 A	V_F	0.55	0.70		0.85		0.95		V	
Maximum Instantaneous Reverse Current $T_A = 25^{\circ}C$ at Rated DC Reverse Voltage $T_A = 100^{\circ}C$	I_R	1.0 50								mA
Typical Junction Capacitance ⁽¹⁾	C_j	800	500							pF
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	45								°C/W
Operating Junction Temperature Range	T_j	-55 ~ +150								°C
Storage Temperature Range	T_{stg}	-55 ~ +150								°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

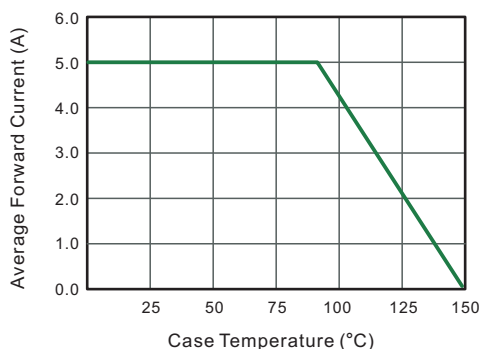


Fig.2 Typical Reverse Characteristics

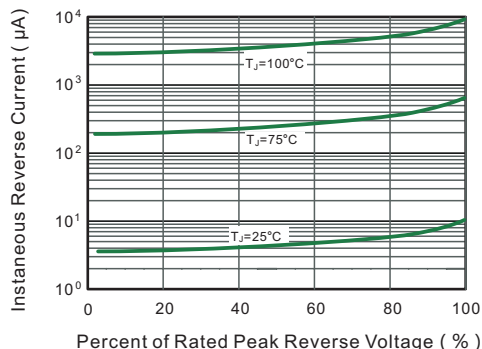


Fig.3 Typical Forward Characteristic

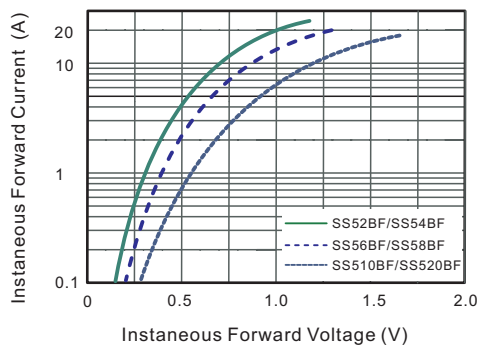


Fig.4 Typical Junction Capacitance

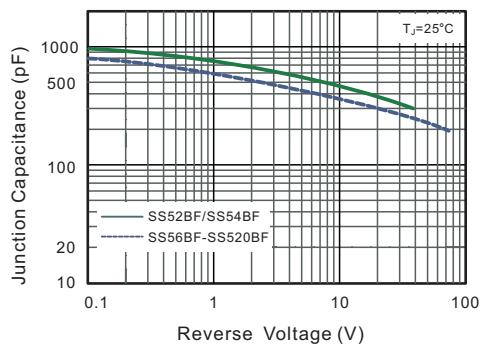


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

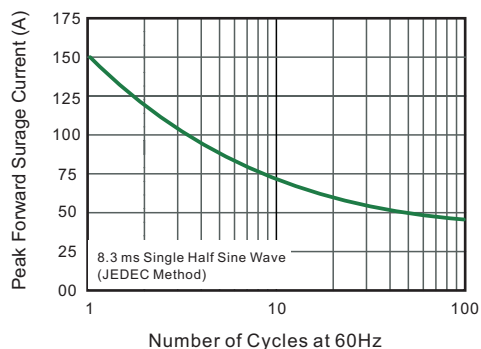
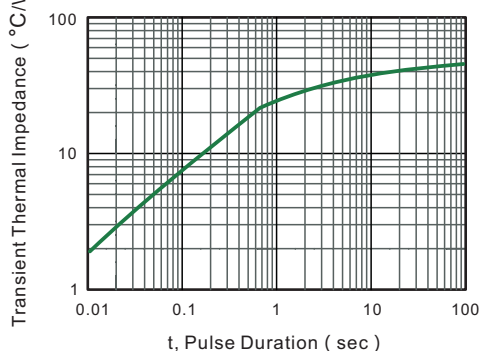


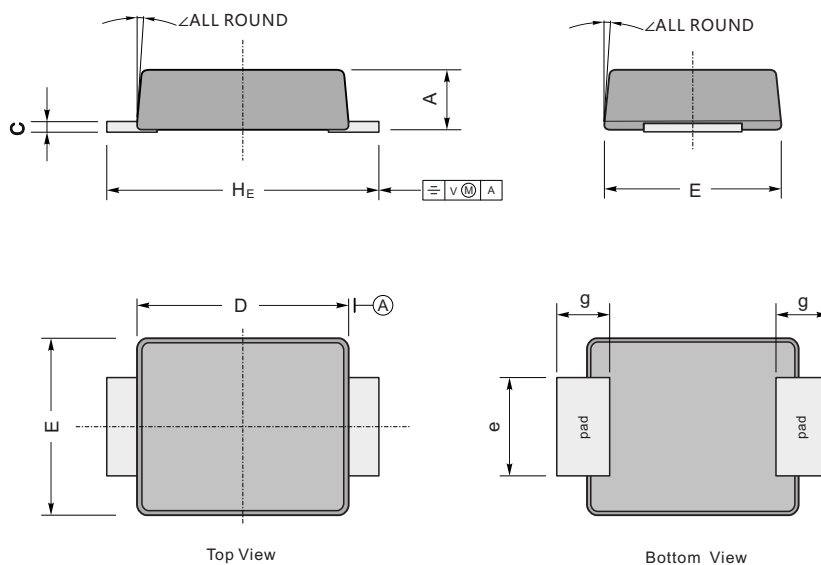
Fig.6- Typical Transient Thermal Impedance



Package Outline

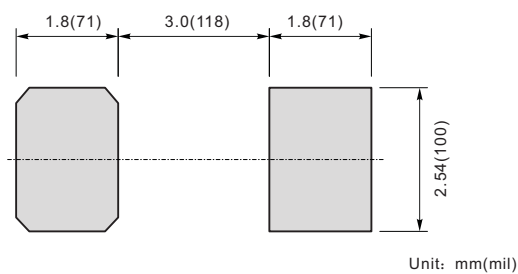
SMBF

Plastic surface mounted package; 2 leads



UNIT		A	C	D	E	H _E	e	g	∠
mm	max	1.3	0.26	4.4	3.7	5.5	2.2	1.0	9°
	min	1.1	0.18	4.2	3.5	5.1	1.9		
mil	max	51	10	173	146	216	86	40	
	min	43	7	165	138	200	75		

The recommended mounting pad size



Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
SMBF	Tape/Reel, 13" reel	5000	EIA-481-1